

Features

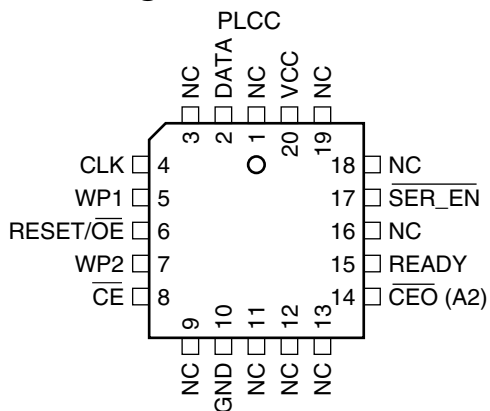
- EE Programmable 524,288 x 1- and 1,048,576 x 1-bit Serial Memories Designed to Store Configuration Programs for Field Programmable Gate Arrays (FPGAs)
- In-System Programmable via 2-wire Bus
- Simple Interface to SRAM FPGAs
- Compatible with Atmel AT6000, AT40K FPGAs, Altera FLEX[®] Devices, Lucent ORCA[®] FPGAs, Xilinx XC3000, XC4000, XC5200, SPARTAN[®] and Virtex[®] FPGAs
- Cascadable Read Back to Support Additional Configurations or Future Higher-density Arrays
- Low-power CMOS EEPROM Process
- Programmable Reset Polarity
- Available in PLCC Package (Pin-compatible Across Product Family)
- Emulation of Atmel's AT24CXXX Serial EEPROMs
- Available in 3.3V ± 10% LV and 5V ± 5% C Versions
- System-friendly READY Pin
- Low-power Standby Mode

Description

The AT17C512/010 and AT17LV512/010 (high-density AT17 Series) FPGA Configuration EEPROMs (Configurators) provide an easy-to-use, cost-effective configuration memory for Field Programmable Gate Arrays. The AT17 Series is packaged in the popular 20-pin PLCC. The AT17 Series family uses a simple serial-access procedure to configure one or more FPGA devices. The AT17 Series organization supplies enough memory to configure one or multiple smaller FPGAs. The user can select the polarity of the reset function by programming four EEPROM bytes. These devices also support a write protection mode and a system-friendly READY pin, which signifies a "good" power level to the FPGA and can be used to ensure reliable system power-up.

The AT17 Configurator Series can be programmed with industry-standard programmers, or Atmel's ATDH2200E Programming Kit.

Pin Configurations



FPGA Configuration EEPROM Memory

512K and 1M

AT17C512

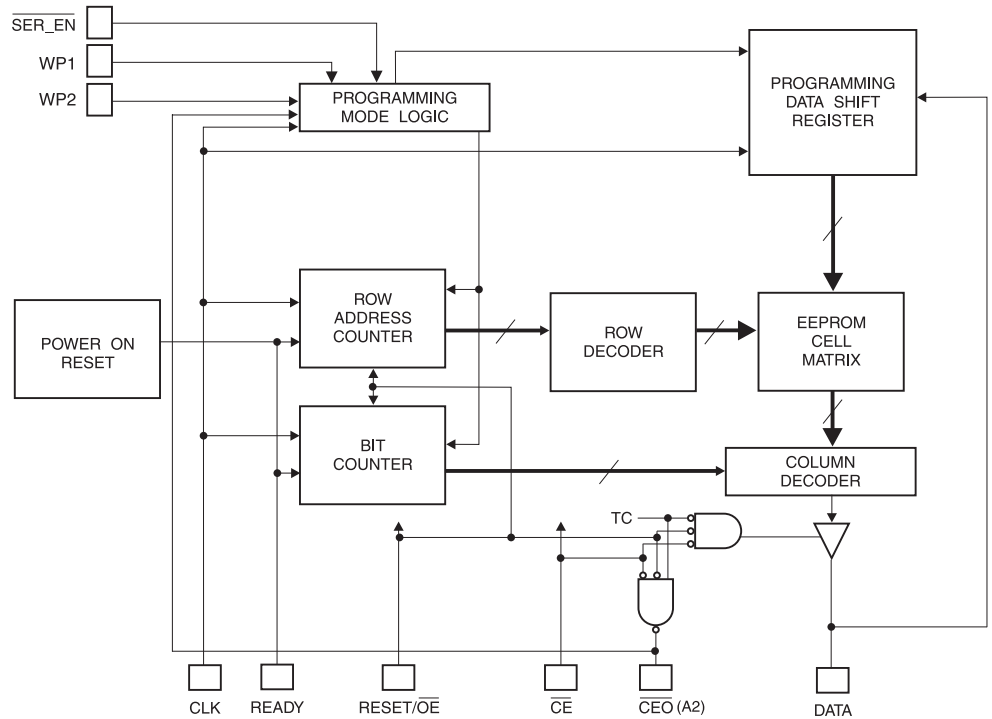
AT17LV512

AT17C010

AT17LV010



Block Diagram



FPGA Master Serial Mode Summary

The I/O and logic functions of the FPGA and their associated interconnections are established by a configuration program. The program is loaded either automatically upon power-up, or on command, depending on the state of the FPGA mode pins. In Master Mode, the FPGA automatically loads the configuration program from an external memory. The AT17 Serial Configuration EEPROM has been designed for compatibility with the Master Serial Mode.

This document discusses the AT40K FPGA interface. For more details or AT6000 FPGA applications, please reference "AT40K Series Configuration" or "AT6000 Series Configuration" application notes.

Controlling the High-density AT17 Series Serial EEPROMs During Configuration

Most connections between the FPGA device and the AT17 Serial Configuration EEPROM are simple and self-explanatory:

The DATA output of the AT17 Series Configurator drives DIN of the FPGA devices.

The master FPGA CCLK output drives the CLK input of the AT17 Series Configurator.

The $\overline{\text{CEO}}$ output of any AT17C/LV512/010 drives the $\overline{\text{CE}}$ input of the next AT17C/LV512/010 in a cascade chain of EEPROMs.

$\overline{\text{SER_EN}}$ must be connected to VCC, (except during ISP).

The READY pin is available as an open-collector indicator of the device's reset status; it is driven Low while the device is in its power-on reset cycle and released (tri-stated) when the cycle is complete.

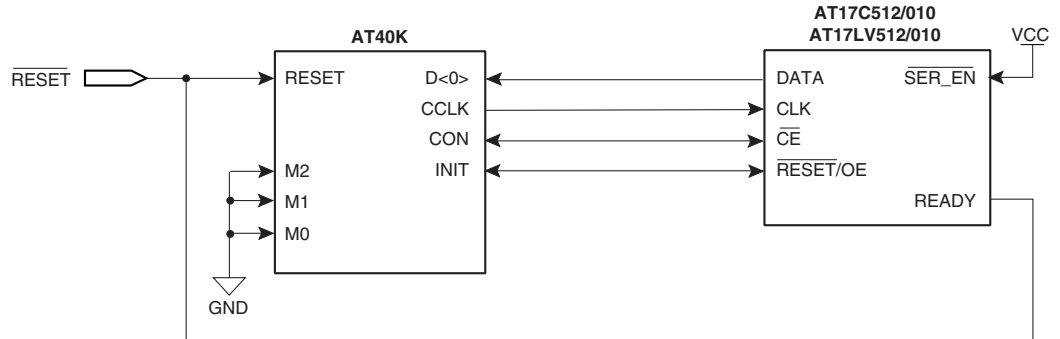
There are two different ways to use the inputs $\overline{\text{CE}}$ and $\overline{\text{OE}}$.

Condition 1

The simplest connection is to have the FPGA $\overline{\text{CON}}$ pin drive both $\overline{\text{CE}}$ and $\text{RESET}/\overline{\text{OE}}^{(1)}$ in parallel. Due to its simplicity, however, this method will fail if the FPGA receives an external reset condition during the configuration cycle. If a system reset is applied to the FPGA, it will abort the original configuration and then reset itself for a new configuration, as intended. Of course, the AT17 Series Configurator does not see the external reset signal and will not reset its internal address counters and, consequently, will remain out of sync with the FPGA for the remainder of the configuration cycle.

Note: 1. For this condition, the reset polarity of the EEPROM must be set active High.

Figure 1. Condition 2 Connection



Notes: 1. Use of the READY pin is optional.
2. Reset polarity of EEPROM must be set active Low.

Condition 2

The FPGA $\overline{\text{CON}}$ output drives only the $\overline{\text{CE}}$ input of the AT17 Series Configurator, while the $\text{RESET}/\overline{\text{OE}}$ input is driven by the FPGA INIT pin (Figure 1). This connection works under all normal circumstances, even when the user aborts a configuration before $\overline{\text{CON}}$ has gone high. A Low level on the $\text{RESET}/\overline{\text{OE}}^{(1)}$ input – during FPGA reset – clears the Configurator’s internal address pointer, so that the reconfiguration starts at the beginning.

Note: 1. For this condition the reset polarity of the EEPROM must be set active Low.

The AT17 Series Configurator does not require an inverter for either condition since the RESET polarity is programmable.

Cascading Serial Configuration EEPROMs

For multiple FPGAs configured as a daisy-chain, or for future FPGAs requiring larger configuration memories, cascaded Configurators provide additional memory.

As the last bit from the first Configurator is read, the clock signal to the Configurator asserts its $\overline{\text{CEO}}$ output Low and disables its DATA line driver. The second Configurator recognizes the Low level on its $\overline{\text{CE}}$ input and enables its DATA output.

After configuration is complete, the address counters of all cascaded Configurators are reset if the $\text{RESET}/\overline{\text{OE}}$ on each Configurator is driven to its active (default High) level.

If the address counters are not to be reset upon completion, then the $\text{RESET}/\overline{\text{OE}}$ input can be tied to its inactive (default Low) level.

AT17 Series Reset Polarity

The AT17 Series Configurator allows the user to program the reset polarity as either $\text{RESET}/\overline{\text{OE}}$ or $\overline{\text{RESET}}/\text{OE}$. This feature is supported by industry-standard programmer algorithms. For more details on programming the EEPROMs reset polarity, please



reference the “Programming Specification for Atmel’s FPGA Configuration EEPROMs” application note.

Programming Mode

The programming mode is entered by bringing $\overline{\text{SER_EN}}$ Low. In this mode the chip can be programmed by the 2-wire serial bus. The programming is done at VCC supply only. Programming super voltages are generated inside the chip. See the “Programming Specification for Atmel’s FPGA Configuration EEPROMs” application note for further information. The AT17C parts are read/write at 5V nominal. The AT17LV parts are read/write at 3.3V nominal.

Standby Mode

The AT17C/LV512/010 Series Configurator enters a low-power standby mode whenever $\overline{\text{CE}}$ is asserted High. In this mode, the Configurator consumes less than 0.5 mA of current at 5V. The output remains in a high impedance state regardless of the state of the $\overline{\text{OE}}$ input.

Pin Configurations

20 PLCC Pin	Name	I/O	Description
2	DATA	I/O	Three-state DATA output for configuration. Open-collector bi-directional pin for programming.
4	CLK	I	Clock input. Used to increment the internal address and bit counter for reading and programming.
5	WP1	I	WRITE PROTECT (1). Used to protect portions of memory during programming. Disabled by default due to internal pull-down resistor. This input pin is not used during FPGA loading operations. See the “Programming Specification” application note for more details.
6	RESET/ $\overline{\text{OE}}$	I	RESET/Output Enable input (when $\overline{\text{SER_EN}}$ is High). A Low level on both the $\overline{\text{CE}}$ and RESET/ $\overline{\text{OE}}$ inputs enables the data output driver. A High level on RESET/ $\overline{\text{OE}}$ resets both the address and bit counters. The logic polarity of this input is programmable as either RESET/ $\overline{\text{OE}}$ or RESET/OE. This document describes the pin as RESET/ $\overline{\text{OE}}$.
7	WP2	I	WRITE PROTECT (2). Used to protect portions of memory during programming. Disabled by default due to internal pull-down resistor. This input pin is not used during FPGA loading operations. See the “Programming Specification” application note for more details.
8	$\overline{\text{CE}}$	I	Chip Enable input. Used for device selection. A Low level on both $\overline{\text{CE}}$ and $\overline{\text{OE}}$ enables the data output driver. A High level on $\overline{\text{CE}}$ disables both the address and bit counters and forces the device into a low-power standby mode. Note that this pin will <u>not</u> enable/disable the device in the 2-wire Serial Programming Mode (i.e., when $\overline{\text{SER_EN}}$ is Low).
10	GND		Ground pin. A 0.2 μF decoupling capacitor between VCC and GND is recommended.
14	$\overline{\text{CEO}}$	O	Chip Enable Output. This signal is asserted Low on the clock cycle following the last bit read from the memory. It will stay Low as long as $\overline{\text{CE}}$ and $\overline{\text{OE}}$ are both Low. It will then follow $\overline{\text{CE}}$ until $\overline{\text{OE}}$ goes High. Thereafter, $\overline{\text{CEO}}$ will stay High until the entire EEPROM is read again.
	A2	I	Device selection input, A2. This is used to enable (or select) the device during programming (i.e., when $\overline{\text{SER_EN}}$ is Low; see the “Programming Specification” application note for more details).
15	READY	O	Open collector reset state indicator. Driven Low during power-up reset, released when power-up is complete. (Recommend a 4.7 k Ω pull-up on this pin if used).
17	$\overline{\text{SER_EN}}$	I	Serial enable must be held High during FPGA loading operations. Bringing $\overline{\text{SER_EN}}$ Low enables the 2-wire Serial Programming Mode.
20	VCC		+3.3V/+5V power supply pin.

Absolute Maximum Ratings*

Operating Temperature	-55°C to +125°C
Storage Temperature	-65°C to +150°C
Voltage on Any Pin with Respect to Ground	-0.1V to $V_{CC} + 0.5V$
Supply Voltage (V_{CC})	-0.5V to +7.0V
Maximum Soldering Temp. (10 sec. @ 1/16 in.).....	260°C

*NOTICE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time may affect device reliability.

Operating Conditions

Symbol	Description		AT17CXXX		AT17LVXXX		Units
			Min	Max	Min	Max	
V_{CC}	Commercial	Supply voltage relative to GND -0°C to +70°C	4.75	5.25	3.0	3.6	V
	Industrial	Supply voltage relative to GND -40°C to +85°C	4.5	5.5	3.0	3.6	V
	Military	Supply voltage relative to GND -55°C to +125°C	4.5	5.5	3.0	3.6	V





DC Characteristics

$V_{CC} = 5V \pm 5\%$ Commercial/ $5V \pm 10\%$ Ind./Mil.

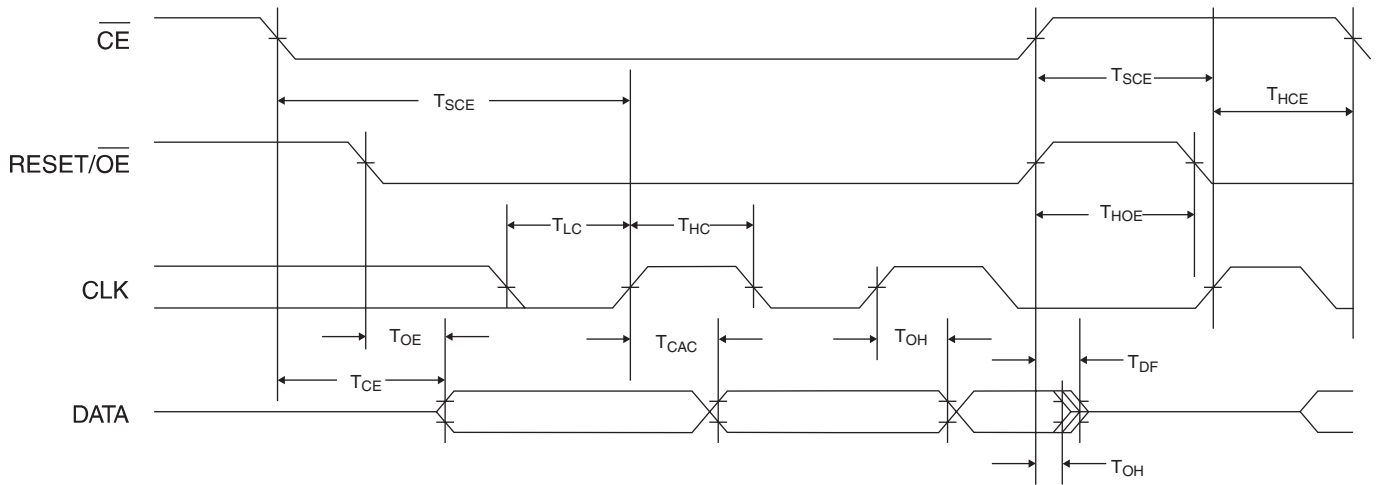
Symbol	Description		Min	Max	Units
V_{IH}	High-level input voltage		2.0	V_{CC}	V
V_{IL}	Low-level input voltage		0	0.8	V
V_{OH}	High-level output voltage ($I_{OH} = -4$ mA)	Commercial	3.86		V
V_{OL}	Low-level output voltage ($I_{OL} = +4$ mA)			0.32	V
V_{OH}	High-level output voltage ($I_{OH} = -4$ mA)	Industrial	3.76		V
V_{OL}	Low-level output voltage ($I_{OL} = +4$ mA)			0.37	V
V_{OH}	High-level output voltage ($I_{OH} = -4$ mA)	Military	3.7		V
V_{OL}	Low-level output voltage ($I_{OL} = +4$ mA)			0.4	V
I_{CCA}	Supply current, active mode			10	mA
I_L	Input or output leakage current ($V_{IN} = V_{CC}$ or GND)		-10	10	μ A
I_{CCS}	Supply current, standby mode	Commercial		0.5	mA
		Industrial/Military		0.5	mA

DC Characteristics

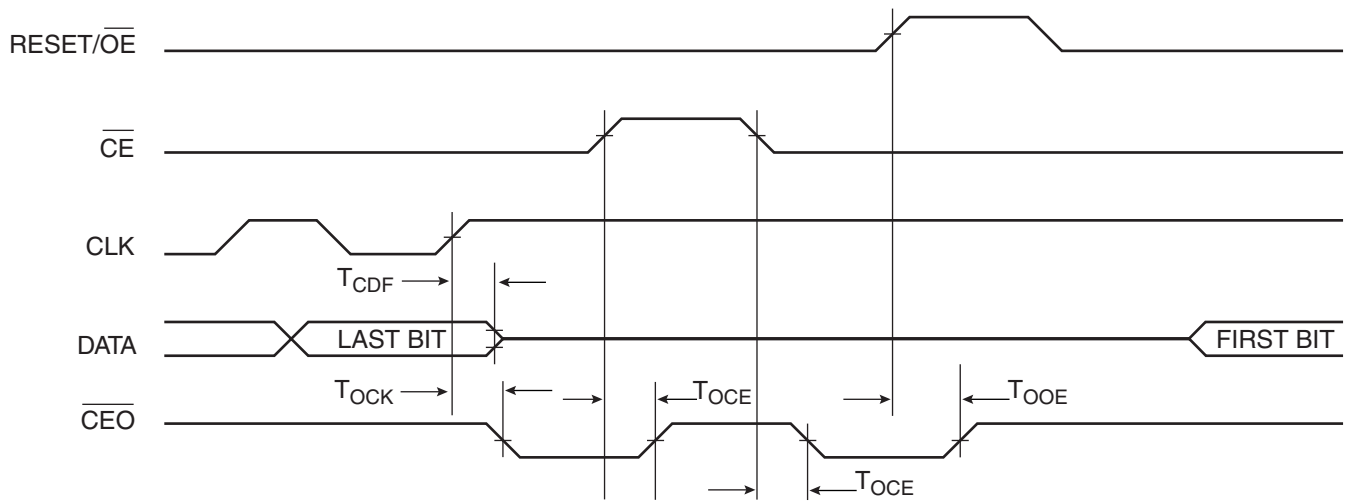
$V_{CC} = 3.3V \pm 10\%$

Symbol	Description		Min	Max	Units
V_{IH}	High-level input voltage		2.0	V_{CC}	V
V_{IL}	Low-level input voltage		0	0.8	V
V_{OH}	High-level output voltage ($I_{OH} = -2.5$ mA)	Commercial	2.4		V
V_{OL}	Low-level output voltage ($I_{OL} = +3$ mA)			0.4	V
V_{OH}	High-level output voltage ($I_{OH} = -2$ mA)	Industrial	2.4		V
V_{OL}	Low-level output voltage ($I_{OL} = +3$ mA)			0.4	V
V_{OH}	High-level output voltage ($I_{OH} = -2$ mA)	Military	2.4		V
V_{OL}	Low-level output voltage ($I_{OL} = +2.5$ mA)			0.4	V
I_{CCA}	Supply current, active mode			5	mA
I_L	Input or output leakage current ($V_{IN} = V_{CC}$ or GND)		-10	10	μ A
I_{CCS}	Supply current, standby mode	Commercial		100	μ A
		Industrial/Military		100	μ A

AC Characteristics



AC Characteristics When Cascading





AC Characteristics for AT17C512/010

$V_{CC} = 5V \pm 5\%$ Commercial/ $V_{CC} = 5V \pm 10\%$ Ind./Mil.

Symbol	Description	Commercial		Industrial/Military ⁽¹⁾		Units
		Min	Max	Min	Max	
$T_{OE}^{(2)}$	\overline{OE} to Data Delay		30		35	ns
$T_{CE}^{(2)}$	\overline{CE} to Data Delay		45		45	ns
$T_{CAC}^{(2)}$	CLK to Data Delay		50		50	ns
T_{OH}	Data Hold From \overline{CE} , \overline{OE} , or CLK	0		0		ns
$T_{DF}^{(1)}$	\overline{CE} or \overline{OE} to Data Float Delay		50		50	ns
T_{LC}	CLK Low Time	20		20		ns
T_{HC}	CLK High Time	20		20		ns
T_{SCE}	\overline{CE} Setup Time to CLK (to guarantee proper counting)	20		25		ns
T_{HCE}	\overline{CE} Hold Time from CLK (to guarantee proper counting)	0		0		ns
T_{HOE}	\overline{OE} High Time (guarantees counter is reset)	20		20		ns
F_{MAX}	MAX Input Clock Frequency	15		15		MHz

- Notes:
1. Preliminary specifications for military operating range only.
 2. AC test load = 50 pF.
 3. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady state active levels.

AC Characteristics for AT17C512/010 When Cascading

$V_{CC} = 5V \pm 5\%$ Commercial/ $V_{CC} = 5V \pm 10\%$ Ind./Mil.

Symbol	Description	Commercial		Industrial/Military ⁽¹⁾		Units
		Min	Max	Min	Max	
$T_{CDF}^{(3)}$	CLK to Data Float Delay		50		50	ns
$T_{OCK}^{(2)}$	CLK to \overline{CEO} Delay		35		40	ns
$T_{OCE}^{(2)}$	\overline{CE} to \overline{CEO} Delay		35		35	ns
$T_{OOE}^{(2)}$	RESET/ \overline{OE} to \overline{CEO} Delay		30		30	ns
F_{MAX}	MAX Input Clock Frequency	12.5		12.5		MHz

- Notes:
1. Preliminary specifications for military operating range only.
 2. AC test load = 50 pF.
 3. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady state active levels.

AC Characteristics for AT17LV512/010

$V_{CC} = 3.3V \pm 10\%$

Symbol	Description	Commercial		Industrial/Military ⁽¹⁾		Units
		Min	Max	Min	Max	
$T_{OE}^{(2)}$	\overline{OE} to Data Delay		50		55	ns
$T_{CE}^{(2)}$	\overline{CE} to Data Delay		55		60	ns
$T_{CAC}^{(2)}$	CLK to Data Delay		55		60	ns
T_{OH}	Data Hold From \overline{CE} , \overline{OE} , or CLK	0		0		ns
$T_{DF}^{(3)}$	\overline{CE} or \overline{OE} to Data Float Delay		50		50	ns
T_{LC}	CLK Low Time	25		25		ns
T_{HC}	CLK High Time	25		25		ns
T_{SCE}	\overline{CE} Setup Time to CLK (to guarantee proper counting)	30		35		ns
T_{HCE}	\overline{CE} Hold Time from CLK (to guarantee proper counting)	0		0		ns
T_{HOE}	\overline{OE} High Time (guarantees counter is reset)	25		25		ns
F_{MAX}	MAX Input Clock Frequency	15		10		MHz

- Notes:
1. Preliminary specifications for military operating range only.
 2. AC test load = 50 pF.
 3. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady state active levels

AC Characteristics for AT17LV512/010 When Cascading

$V_{CC} = 3.3V \pm 10\%$

Symbol	Description	Commercial		Industrial/Military ⁽¹⁾		Units
		Min	Max	Min	Max	
$T_{CDF}^{(3)}$	CLK to Data Float Delay		50		50	ns
$T_{OCK}^{(2)}$	CLK to \overline{CEO} Delay		50		55	ns
$T_{OCE}^{(2)}$	\overline{CE} to \overline{CEO} Delay		35		40	ns
$T_{OOE}^{(2)}$	RESET/ \overline{OE} to \overline{CEO} Delay		35		35	ns
F_{MAX}	MAX Input Clock Frequency	12.5		10		MHz

- Notes:
1. Preliminary specifications for military operating range only.
 2. AC test load = 50 pF.
 3. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady state active levels.



Ordering Information – 5V Devices

Memory Size	Ordering Code	Package	Operation Range
512K	AT17C512-10JC	20J	Commercial (0°C to 70°C)
	AT17C512-10JI	20J	Industrial (-40°C to 85°C)
1M	AT17C010-10JC	20J	Commercial (0°C to 70°C)
	AT17C010-10JI	20J	Industrial (-40°C to 85°C)

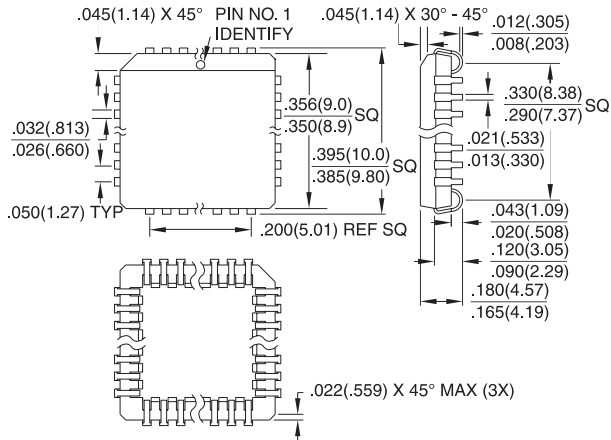
Ordering Information – 3.3V Devices

Memory Size	Ordering Code	Package	Operation Range
512K	AT17LV512-10JC	20J	Commercial (0°C to 70°C)
	AT17LV512-10JI	20J	Industrial (-40°C to 85°C)
1M	AT17LV010-10JC	20J	Commercial (0°C to 70°C)
	AT17LV010-10JI	20J	Industrial (-40°C to 85°C)

Package Type	
20J	20-lead, Plastic J-leaded Chip Carrier (PLCC)

Packaging Information

20J, 20-lead, Plastic J-leaded Chip Carrier (PLCC)
 Dimensions in Inches and (Millimeters)





Atmel Headquarters

Corporate Headquarters

2325 Orchard Parkway
San Jose, CA 95131
TEL (408) 441-0311
FAX (408) 487-2600

Europe

Atmel SarL
Route des Arsenaux 41
Casa Postale 80
CH-1705 Fribourg
Switzerland
TEL (41) 26-426-5555
FAX (41) 26-426-5500

Asia

Atmel Asia, Ltd.
Room 1219
Chinachem Golden Plaza
77 Mody Road Tsimhatsui
East Kowloon
Hong Kong
TEL (852) 2721-9778
FAX (852) 2722-1369

Japan

Atmel Japan K.K.
9F, Tonetsu Shinkawa Bldg.
1-24-8 Shinkawa
Chuo-ku, Tokyo 104-0033
Japan
TEL (81) 3-3523-3551
FAX (81) 3-3523-7581

Atmel Operations

Atmel Colorado Springs

1150 E. Cheyenne Mtn. Blvd.
Colorado Springs, CO 80906
TEL (719) 576-3300
FAX (719) 540-1759

Atmel Rousset

Zone Industrielle
13106 Rousset Cedex
France
TEL (33) 4-4253-6000
FAX (33) 4-4253-6001

Atmel Smart Card ICs

Scottish Enterprise Technology Park
East Kilbride, Scotland G75 0QR
TEL (44) 1355-357-000
FAX (44) 1355-242-743

Atmel Grenoble

Avenue de Rochepleine
BP 123
38521 Saint-Egreve Cedex
France
TEL (33) 4-7658-3000
FAX (33) 4-7658-3480

Atmel Configurator Hotline

(408) 436-4118

Atmel Configurator e-mail

configurator@atmel.com

FAQ

Available on web site

Fax-on-Demand

North America:
1-(800) 292-8635
International:
1-(408) 441-0732

e-mail

literature@atmel.com

Web Site

<http://www.atmel.com>

BBS

1-(408) 436-4309

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